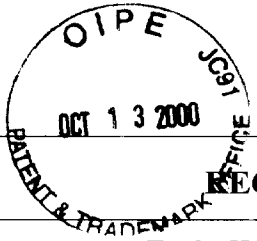


11-09-2000



101511117

Atty. Docket No.: 1781-202P

Page 1 of 1

## RECORDATION FORM COVER SHEET

MED 10-13-00

To the Honorable Commissioner of Patents and Trademarks:  
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Junfeng ZHANG, Cheng Qiang CUI, Thiam Beng LIM and En-Tang KANG

Additional name(s) of conveying party(ies) attached?

☐ YES ☒ NO

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other:

Date: September 21, 2000

2. Name and address of receiving party(ies)

Name: Institute of Microelectronics

Internal Address:

Street Address: 11 Science Park Road

City: Science Park II State: ZIP:

Country: Singapore Postal Code: 117685

Additional name(s) & address(es) attached? ☒ YES ☐ NO

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).

09/604,959

B. Patent No.(s).

Additional numbers attached? ☐ YES ☒ NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: BIRCH, STEWART, KOLASCH &amp; BIRCH, LLP

Street Address: P.O. BOX 747

City: FALLS CHURCH State: VA ZIP: 22040-0747

Country: USA

6. Total No. of applications/patents involved: one (1)

7. Total fee (37 C.F.R. § 3.41): \$40.00

☒ Enclosed☒ Authorized to be charged to deposit account, if no fee attached.

8. Deposit account number: 02-2448

(Attach triplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James M. Slattery, #28,380

Name of Person Signing/Reg. No.

Signature

October 13, 2000

Date

Total number of pages including cover sheet, attachments, and document: four (4)

11/08/2000 RAHME1 00000169 09604959

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(Rev. 04/19/2000)

PATENT  
REEL: 011214 FRAME: 0832

Attachment to  
RECORDATION FORM COVER SHEET

Continuation of Box 1--Name of conveying party(ies):

Continuation of Box 2--Name and address of receiving party(ies):

**National University of Singapore, 10 Kent Ridge Crescent, Singapore 119260**

Continuation of Box 4--Application number(s) or patent number(s):

ATTORNEY DOCKET NO.

1781-0202P

## ASSIGNMENT

Application No. 09/604,959

Filed June 28, 2000

**Insert Name(s)  
of Inventor(s)** ➡

WHEREAS, Junfeng ZHANG,

Cheng Qiang CUI,

Thiam Beng LIM, and

En- Tang KANG

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in \_\_\_\_\_

**Insert Title  
of Invention** ➡

METHOD FOR LAMINATION OF FLUOROPOLYMER TO METAL AND PRINTED CIRCUIT

BOARD (PCB) SUBSTRATE

for which an application for Letters Patent of the United States of America has been executed by the undersigned

**Insert Date  
of Signing of  
Application** ➡

on September 21, 2000; and

**Insert Name  
of Assignee** ➡

WHEREAS, (A) Institute of Microelectronics and

(B) National University of Singapore

**Insert Address  
of Assignee** ➡

of (A) 11 Science Park Road, Science Park II, Singapore 117685 and

(B) 10 Kent Ridge Crescent, Singapore 119260

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

**CHECK BOX  
IF APPROPRIATE** ➡

☐ in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

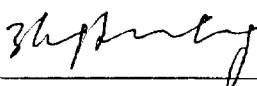
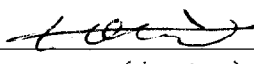
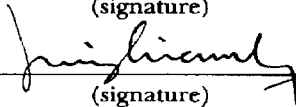
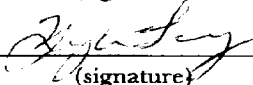
The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	<u>21 Sep. 2000</u>	Name of Inventor	<u></u> Junfeng ZHANG (signature)
Date	<u>21 Sep. 2000</u>	Name of Inventor	<u></u> Cheng Qiang CUI (signature)
Date	<u>21 Sep. 2000</u>	Name of Inventor	<u></u> Thiam Beng LIM (signature)
Date	<u>21 Sep. 2000</u>	Name of Inventor	<u></u> En-Tang KANG (signature)
Date	_____	Name of Inventor	_____ (signature)
Date	_____	Name of Inventor	_____ (signature)